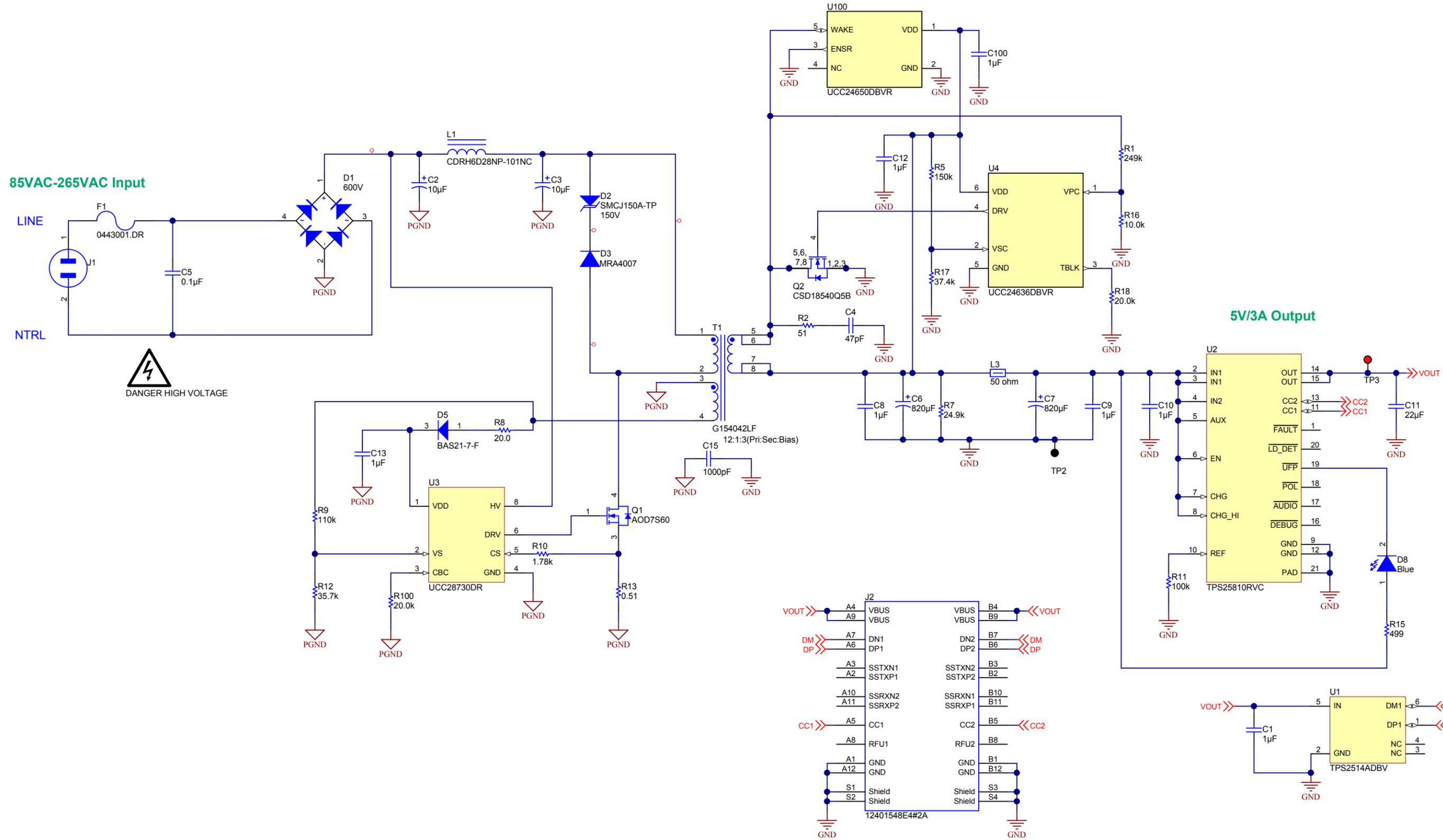


Assembly Notes:



PCB Number: PMP11295
PCB Rev: D

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Orderable: N/A	Designed for:	Mod. Date: 10/28/2015
TID #:	Project Title: Universal AC Input; 5V/3A USB-C Charger	
Number: PMP11295	Rev: D	Sheet Title:
SVN Rev: Version control disabled		Assembly Variant: 001
Drawn By:	File: PMP11295_REV.D_SchDoc	Sheet: 1 of 1
Engineer: B King	Contact: http://www.ti.com/support	Size: B



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